

### MAAM-011252-DIE Rev. V2

Features

- 20 dB Flat Broadband Gain to 8 GHz
- Low Noise Figure:
  - 1.2 dB Noise Figure to 1.5 GHz
  - 1.7 dB Noise Figure @ 6 GHz
  - 2.3 dB Noise Figure @ 8 GHz
- High Linearity OIP3:
  - 36 dBm @ 1.5 GHz
  - 33 dBm @ 6 GHz
  - 30 dBm @ 8 GHz
- Internal Matching to 50 Ω
- Single Voltage Bias: 3 5 V
- Integrated Active Bias Circuit
- RoHS\* Compliant

### Applications

• ISM/MM

### Description

The MAAM-011252-DIE is a broadband high dynamic range, single stage MMIC LNA. This bare die is 0.795 x 0.715 mm. The amplifier is internally matched to provide flat gain and good return losses to 8 GHz without any external matching components. Only DC blocking capacitors and an RF choke with bypass capacitance is required.

This low noise amplifier has an integrated active bias circuit allowing direct connection to 3 V or 5 V bias and minimizing variations over temperature and process.

### **Ordering Information**

Part Number	Package	
MAAM-011252-DIE	Bare Die	

# Functional Block Diagram



# Pin Configuration<sup>1</sup>

Pin #	Pin Name	Description	
1	RF <sub>IN</sub>	RF Input	
2	$RF_{OUT}/V_{DD}$	RF Output / Drain Voltage	
3	NC	No Connection	

1. Bottom of die is RF and thermal ground.

\* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

1

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

For further information and support please visit. https://www.macom.com/support



### **MAAM-011252-DIE**

Rev. V2

### Electrical Specifications: $V_{DD}$ = 5 V, +25°C, $Z_0$ = 50 $\Omega$ (all data is GSG probed)

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	0.03 - 8 GHz	dB	18	20	
Noise Figure	0.1 - 1.5 GHz 6.0 GHz 8.0 GHz	dB		1.2 1.7 2.3	_
Input Return Loss	0.03 - 8 GHz	dB	—	12	—
Output Return Loss	0.03 - 8 GHz	dB	_	12	
Output IP3	P <sub>IN</sub> = -15 dBm per tone, 6 MHz spacing 0.03 - 3 GHz 6 GHz 8 GHz	dBm		34 33 30	_
Output IP2	P <sub>IN</sub> = -15 dBm per tone, 6 MHz spacing 0.03 - 3 GHz 6 GHz 8 GHz	dBm	_	44 48 50	_
Output P1dB	0.03 - 3 GHz 6 GHz 8 GHz	dBm	_	20 18 14	_
Current	I <sub>DD</sub>	mA	—	60	75

### **Maximum Operating Ratings**

Parameter	Maximum	
RF Input Power CW	5 dBm	
V <sub>DD</sub>	6 V	
I <sub>DQ</sub>	100 mA	
Operating Temperature	-40°C to +85°C	
Junction Temperature <sup>4,5</sup>	+150°C	

- 2. Exceeding any one or combination of these limits may cause permanent damage to this device.
- 3. MACOM does not recommend sustained operation near these survivability limits.
- 4. Operating at nominal conditions with  $T_{\rm J}$   $\leq$  150°C will ensure MTTF > 1 x 10^6 hours.
- 5. Junction Temperature  $(T_J) = T_C + \Theta_{JC} * ((V * I) (P_{OUT} P_{IN}))$ Typical thermal resistance  $(\Theta_{JC}) = 40^{\circ}C/W$

a) For 
$$T_c = 25^{\circ}C$$
,

b) For 
$$T_c = 85^{\circ}C$$
,

# Absolute Maximum Ratings<sup>2,3</sup>

Parameter	Absolute Maximum	
RF Input Power CW	24 dBm	
V <sub>DD</sub>	7 V	
Storage Temperature	-55°C to +150°C	

### **Handling Procedures**

Please observe the following precautions to avoid damage:

### Static Sensitivity

Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1B devices.

2

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



8.0

10.0

+25°C

- --40°C

---+85°C

6.0

5.0

6.0

7.0

8.0

7.0

8.0

9.0

12.0



## Typical Performance Curves @ 5 V / 60 mA, $Z_0 = 50 \Omega$ (all data is GSG probed)

3

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.



# Typical Performance Curves @ 5 V / 60 mA, $Z_0 = 50 \Omega$ (all data is GSG probed)



# OIP2 at P<sub>IN</sub> = -15 dBm/tone, 6MHz Spacing



#### 4

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



### MAAM-011252-DIE Rev. V2

#### **Typical Application Circuit**



# Die Outline<sup>6,7</sup> (0.795 x 0.715 mm)



## Bond Pad Dimensions (µm)

Pad #	Size (x)	Size (y)	Description
1, 3, 6, 8	100	100	GND
2	100	120	RF <sub>IN</sub>
7	100	120	RF <sub>OUT</sub> / V <sub>DD</sub>
4	76	76	No Connection
5	50	50	GND

6. Dimensions are in microns.

7. GND bond pads 1, 3, 5, 6 and 8 are connected to the backside of the die through via holes. These bond pads do not require bond wires. Only pin 2 and 7 require bond wires.

5

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.



MAAM-011252-DIE Rev. V2

MACOM Technology Solutions Inc. ("MACOM"). All rights reserved.

These materials are provided in connection with MACOM's products as a service to its customers and may be used for informational purposes only. Except as provided in its Terms and Conditions of Sale or any separate agreement, MACOM assumes no liability or responsibility whatsoever, including for (i) errors or omissions in these materials; (ii) failure to update these materials; or (iii) conflicts or incompatibilities arising from future changes to specifications and product descriptions, which MACOM may make at any time, without notice. These materials grant no license, express or implied, to any intellectual property rights.

THESE MATERIALS ARE PROVIDED "AS IS" WITH NO WARRANTY OR LIABILITY, EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, INFRINGEMENT OF INTELLECTUAL PROPERTY RIGHT, ACCURACY OR COMPLETENESS, OR SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES WHICH MAY RESULT FROM USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.

<sup>6</sup> 

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit <u>www.macom.com</u> for additional data sheets and product information.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

MACOM: MAAM-011252-DIE